



Product Change Notification

Change Notification #: 919124-00

Change Title: Select Intel® Ethernet Network Adapters

Change Detail: Updates with the Canadian EMI Regulatory Marking, SPOC Address, China ROHS Flyer to Add QR Code on Disti/OBL Label, Clamshell South Korea Logo, and the NVM Image

Date of Publication: May 11, 2026

Key Characteristics of the Change:

Product Design, Product Marking, Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material	August 10, 2026
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Description of Change to the Customer:

The Intel® SKUs listed in the product affected table below will be updated with the following change(s):

1. As communicated in PCN 854898-00 in May 2025, The CAN ICES marking on affected product is being updated from CAN ICES-3(A)/NMB-3(A) to Class B CAN ICES-3(B)/NMB-3(B) to ensure continued compliance with Canadian EMI regulations. Intel is moving from an *interim labelling approach* to a *permanent marking* update. Once existing PCB inventory is depleted, new PCBs will be introduced with Class B marking directly printed on the silkscreen. Customers should expect the TA# and PBA# to be further rolled up compared to the cover-up label version, as part of the permanent silkscreen marking.

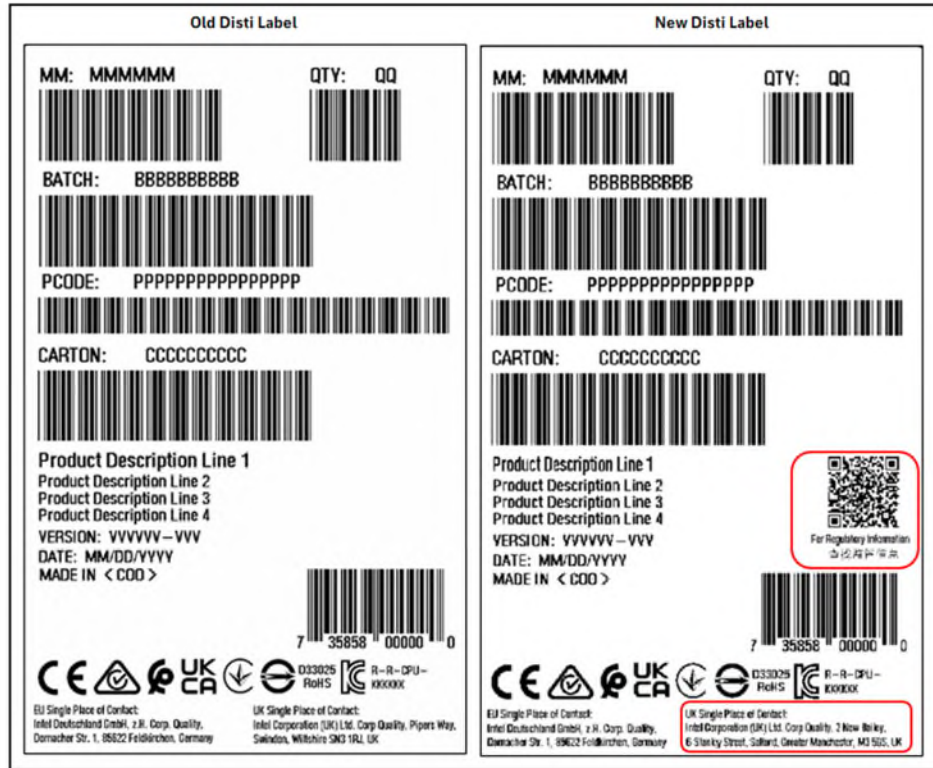
2. As communicated in PCN 859226-00 in July 2025, Intel started to relocate its UKCA Single Place of Contact (SPOC) address. As a result, all product labels would reflect the new address starting October 1, 2025. This update applies to all products listed in the Products Affected/Intel Ordering Codes table. The new address is provided below:

UK Single Place of Contact:

Intel Corporation (UK) Ltd., Attn: Corp. Quality, 2 New Bailey,
6 Stanley Street, Salford, Greater Manchester, M3 5GS, United Kingdom

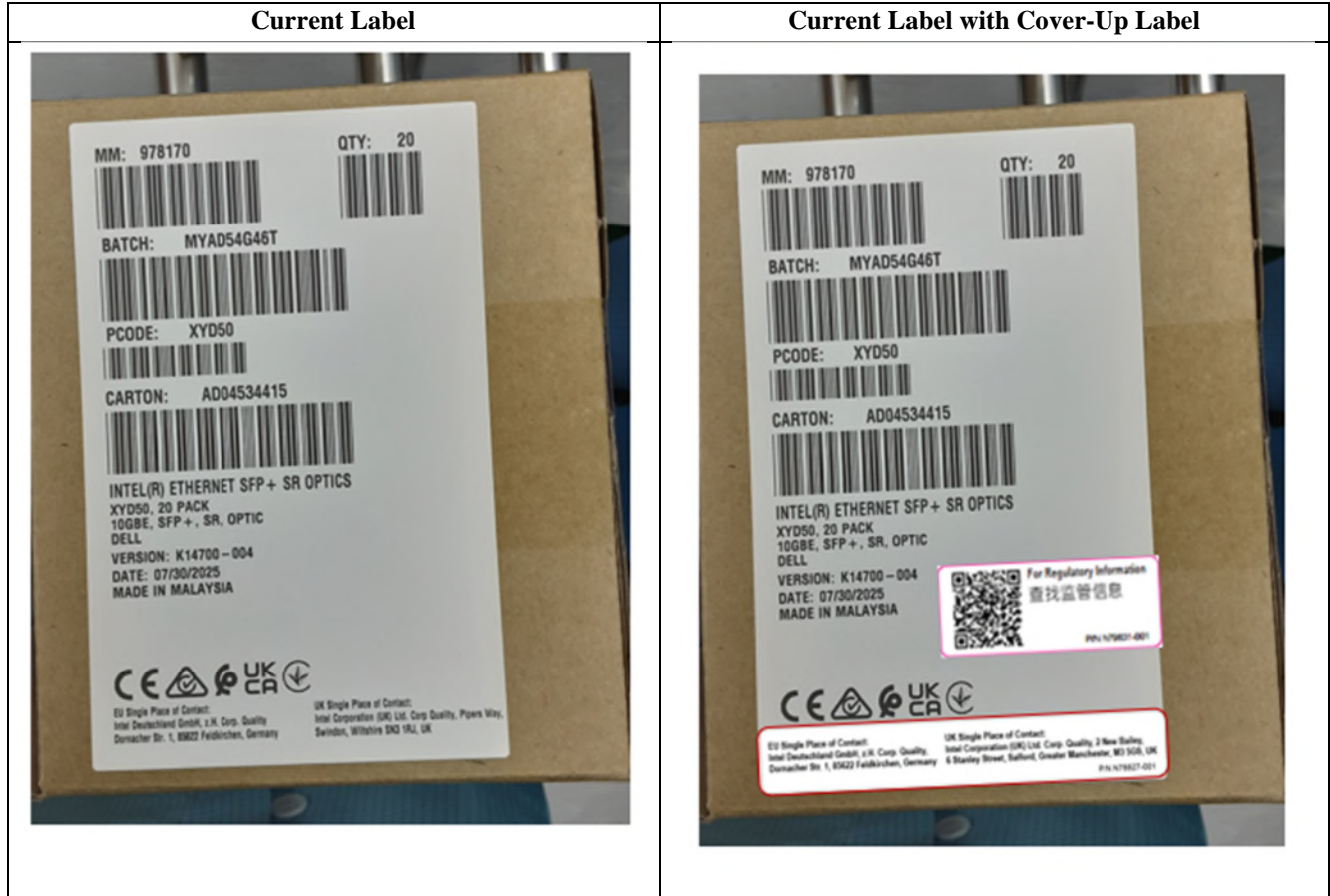
3. Additionally, as communicated in PCN 859226-00 in July 2025 there was an amendment made to GB/T 26572-2011 (better known as China RoHS), and Intel is replacing the China RoHS flyer in Ethernet Network Adapter shipments with a QR code on the outer box label, linking to the product's regulatory site. This change supports compliance with China's updated RoHS regulation, effective January 2026, which adds four phthalates to the list of restricted substances, aligning it with EU RoHS. Customers can access the updated substance list and disclosure table via the QR code. Image of the label before/after the QR code are shown below:

QR Code to outer box labels replacing China RoHS Flyer



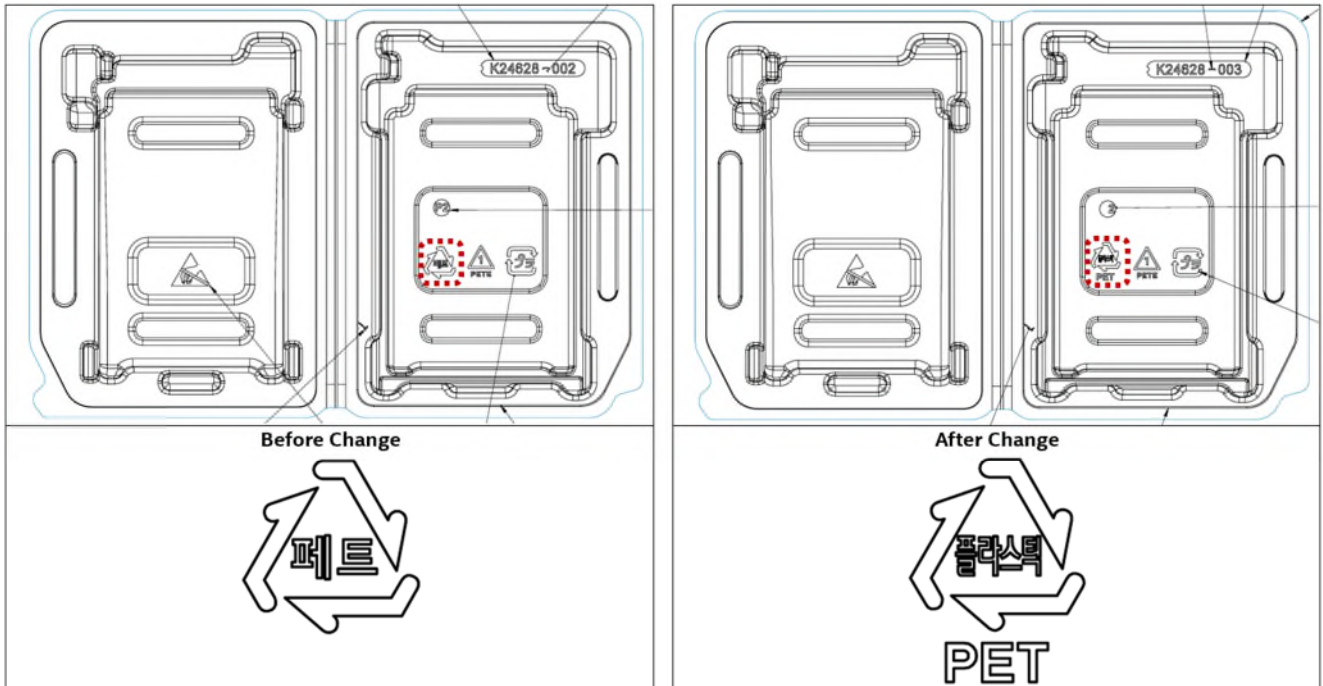
(Picture is for example only, to demonstrate the QR and location placement on the Bulk Pack labels; the actual placement is subject to change per different label template)

4. To meet the October 1, 2025 deadline for updating the UKCA SPOC address, Intel will apply an additional label with the new address and a QR code over the existing EU and UKCA SPOC addresses on older inventory where needed. This ensures all shipped products after October 1, 2025 reflect the updated information. The relabeled inventory will remain at their respective TA revision without TA dash roll.



(Picture is for example only, to demonstrate the placement and content of the cover-up label that will be placed on the current Bulk Pack labels; the actual placement is subject to change per different label template)

5. As communicated in PCN 874317-00, there is a permanent update to the South Korean recycling symbol on clamshell packaging. The new clamshell design is shown below. Once existing clamshell inventory K24628-002 is depleted, new clamshell packaging K24628-003 will be introduced.



6. Intel will update the NVM (non-volatile memory) image being programmed onto these cards from LKV 1.10 to the latest NVM **V1.5** for the OCP 3.0 adapters.

- **V1.5** has several added features: <https://www.intel.com/content/www/us/en/secure/content-details/743367/view-details.html>
- Customers who wish to update their older boards to the new NVM **V1.5** can access the NVM update package here: <https://www.intel.com/content/www/us/en/download/845347/non-volatile-memory-nvm-update-package-for-intel-ethernet-e610-series.html>

7. Intel will remove the anti-counterfeit label from adapters that incorporate SPDM (Security Protocol and Data Model) functionality. All applicable security and authentication requirements will continue to be fully met through the integrated SPDM capability.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers.

Customers can expect to receive mixed inventory until current inventory levels are depleted.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

Products Affected/Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
Intel® Ethernet Network Adapter E610-XT2	E610XT2M5	99CFRF	N48010-002	N42545-005	N48010-003	N42545-006
Intel® Ethernet Network Adapter E610-XT2	E610XT2	99CFRD	N56055-002	N42545-005	N56055-003	N42545-006

PCN Revision History:

Date of Revision:

May 11, 2026

Revision Number:

00

Reason:

Originally Published PCN



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No response from customers will be deemed an acceptance of the change, and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below.

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